

ISO9001 & ISO14001 & TS16949 CHILISIN ELECTRONICS CORP. RoHS & Halogen Free & REACH Compliance.

SPECIFICATION FOR APPROVAL

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Customer	
040101101	

Customer P/N:

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Drawing No:

Quantity :

Pcs. Date :

Chilisin P/N:

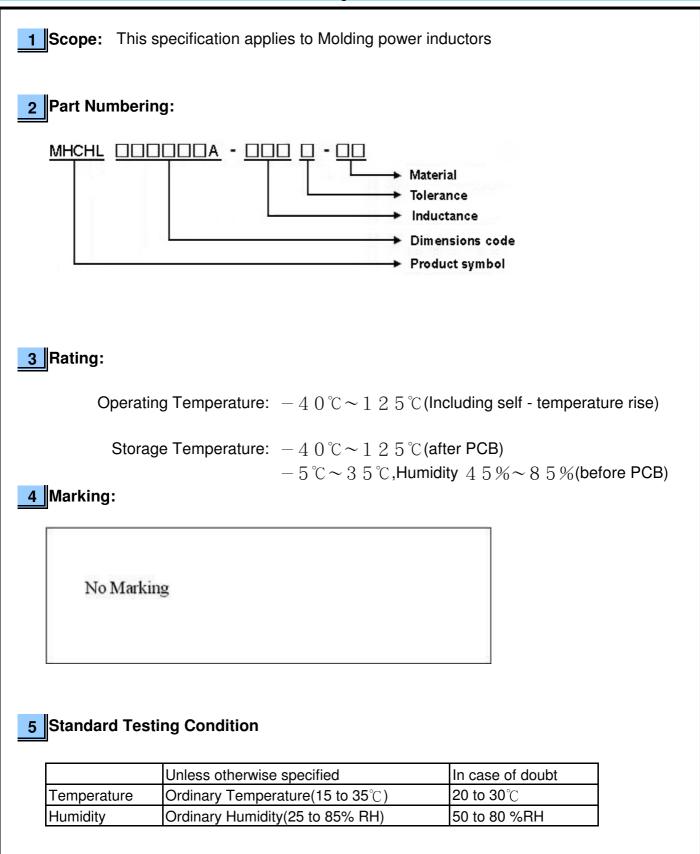
MHCHL252010A-1R0M-Q8

2016/07/05

	SPECIFICATION ACCEPTED BY:			
COMPONENT ENGINEER				
ELECTRICAL ENGINEER				
MECHANICAL ENGINEER				
APPROVED				
REJECTED				
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奇力新電子(河南)有限公 Chilisin Electronics (Henan) Co XiuWu Xian, industry gathering JiaoZuo, Henan China Postal Code:454350 TEL:+86-391-717-0682 FAX:+86-391-717-0666	b., Ltd. area SUZHOU QI YIXIN E No.143,Song Shan F Suzhou,China Postal Code:215129 TEL:+86-512-6841-2	td. M们可益初电丁有限公可 SUZHOU QI YIXIN Electronics Co., Ltd. No.143,Song Shan Rd., Suzhou New District, Suzhou,China		
Drawn by 趙蘭 lan.zhao	Checked by 林 青宏 ch.lin	Approved by 陳瑞揚 ryan.chen		



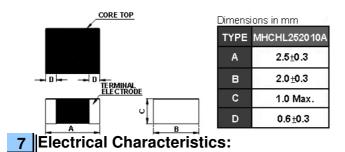
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6 Configuration and Dimensions:



Part No.	Inductance (uH)	Tolerance (±%)	Test Freq.	Irms(A) Max.(Typ)	lsat(A) Max.(Typ)	RDC(mΩ) Max.(Typ)	SRF (MHz)Typ.
MHCHL252010A-R24M-Q8	0.24	20	2MHz,0.2V	5.5(6.5)	8.0(9.5)	18(13)	126
MHCHL252010A-R33M-Q8	0.33	20	2MHz,0.2V	4.8(5.5)	6.5(8.0)	24(18)	95
MHCHL252010A-R47M-Q8	0.47	20	2MHz,0.2V	3.9(4.5)	5.0(6.2)	35(27)	87
MHCHL252010A-R68M-Q8	0.68	20	2MHz,0.2V	3.7(4.2)	4.5(5.6)	40(32)	53
MHCHL252010A-1R0M-Q8	1	20	2MHz,0.2V	3.0(3.5)	3.7(4.6)	53(45)	41
MHCHL252010A-1R5M-Q8	1.5	20	2MHz,0.2V	2.4(2.8)	3.1(3.8)	75(68)	37
MHCHL252010A-2R2M-Q8	2.2	20	2MHz,0.2V	2.2(2.5)	2.5(3.0)	105(87)	29

NOTE:

1.Operating temperature range $-4~0\,^\circ\mathrm{C} \sim 1~2~5\,^\circ\mathrm{C}$ (Including self - temperature rise)

2.Isat for Inductance drop 30% from its value without current.

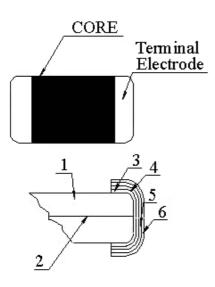
3.Irms for a $40^\circ\!\mathrm{C}$ temperature rise from $25^\circ\!\mathrm{C}$ ambient.

4.All test data is referenced to $25^\circ\!\mathbb{C}$ ambient 5.Absolute maximum voltage 25VDC



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8 MHCHL252010A Series 8.1 Construction:



8.2 Material List:

No	Part	Material
1	Core	Metal Powder
2 Wire		Copper wire
3	Sputter/Plating	Cu
4	Silver Electrode	Ag
5	Plating	Ni
6	Plating	Sn

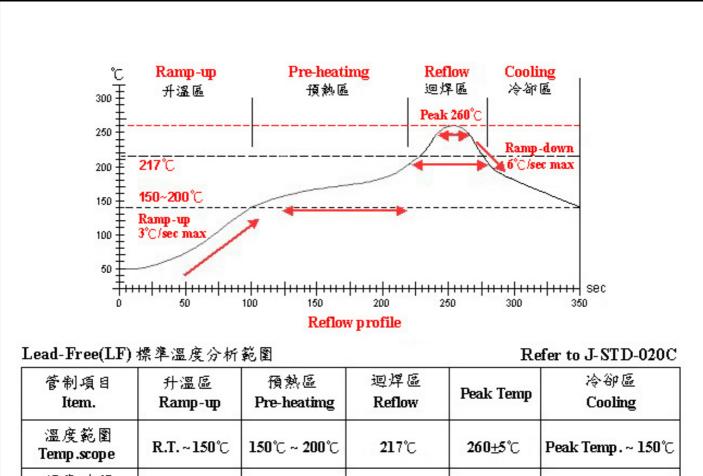


9 Reliability Of Molding power inductors

No	Item	Specification	Test Method			
	Flexure Strength	The forces applied on the right	Test device shall be soldered on the substrate			
	l lonal o oli oligui	conditions must not damage	Substrate Dimension: 100x40x1.6mm			
		the terminal electrode and the	Deflection: 2.0mm			
			1.6			
		metal body	Keeping Time: 30sec			
-1-2	Vibration	Appearance:No damage (for	Test device shall be soldered on the substrate			
		microscope of CASTOR MZ-45 20X)	Oscillation Frequency: 10 to 55 to 10Hz for 1min			
		Inductance change shall be	Amplitude: 1.5mm			
		within ±20%	Time: 2hrs for each axis (X, Y & Z), total 6hrs			
1-1-3	Resistance to Soldering Heat		Pre-heating: 150° , 1min			
1-1-3	Resistance to Soldening Heat					
			al. Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free) Solder Temperature: 260±5°C Immersion Time: 10±1sec			
		electrode should be covered				
		with solder.				
		Inductance: within ±20% of				
		initial value				
1-1-4	Solder ability	The electrodes shall be at	Pre-heating: 150°C, 1min $ // \langle \langle \rangle $			
		least 95% covered with new	Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free) Solder Temperature: 245±5℃			
		solder coating				
		, , , , , , , , , , , , , , , , , , ,	Immersion Time: 4±1sec			
-1-5	Terminal Strength Test	No split termination	Test device shall be soldered on the substrate			
	, , , , , , , , , , , , , , , , , , ,	Chip	then apply a force in the direction of the arrow.			
			Force : 5N			
			Keeping Time: 10±1sec			
		Mounting Pad				
I-2.E	nvironmental Performance	e e				
No	ltem	e Specification	Test Method			
No		e Specification Appearance: No damage	One cycle:			
No	ltem	e Specification Appearance: No damage Inductance:within±20% of	One cycle: Step Temperature (°C) Time (min)			
No	ltem	e Specification Appearance: No damage	One cycle: Image: Constraint of the system Step Temperature (°C) Time (min) 1 -40±3 30			
No	ltem	e Specification Appearance: No damage Inductance:within±20% of	One cycle: Image: Constraint of the second			
No	ltem	e Specification Appearance: No damage Inductance:within±20% of	One cycle: Image: Temperature (°C) Time (min) 1 -40±3 30			
No	ltem	e Specification Appearance: No damage Inductance:within±20% of	One cycle: Temperature (°C) Time (min) 1 -40±3 30 2 25±2 3			
No	ltem	e Specification Appearance: No damage Inductance:within±20% of	One cycle: Temperature (°C) Time (min) 1 -40±3 30 2 25±2 3 3 125±3 5			
No	ltem	e Specification Appearance: No damage Inductance:within±20% of	One cycle: Temperature (°C) Time (min) 1 -40±3 30 2 25±2 3 3 125±3 30 4 25±2 3 Total: 100cycles 100cycles			
No 1-2-1	Item Temperature Cycle	e Specification Appearance: No damage Inductance:within±20% of	One cycle:StepTemperature (°C)Time (min)1 -40 ± 3 302 25 ± 2 33 125 ± 3 r 4 25 ± 2 3Total: 100cycles r Measured after exposure in the room condition for 24hrs			
No 1-2-1	ltem	e Specification Appearance: No damage Inductance:within±20% of	One cycle: Temperature (°C) Time (min) 1 -40±3 30 2 25±2 3 3 125±3 30 4 25±2 3 Total: 100cycles Image: Complexity of the product of the			
No 1-2-1	Item Temperature Cycle	e Specification Appearance: No damage Inductance:within±20% of	One cycle: Temperature (°C) Time (min) 1 -40±3 30 2 25±2 3 3 125±3 30 4 25±2 3 Total: 100cycles Image: condition for 24hrs Measured after exposure in the room condition for 24hrs Temperature: 60±2°C Relative Humidity: 90 ~ 95% / Time: 500hrs			
No 1-2-1 1-2-2	Item Temperature Cycle Humidity Resistance	e Specification Appearance: No damage Inductance:within±20% of	One cycle:Temperature (°C)Time (min)1 -40 ± 3 302 25 ± 2 33 125 ± 3 304 25 ± 2 3Total: 100cyclesImage: Constrained after exposure in the room condition for 24hrsTemperature: $60\pm2^{\circ}C$ Relative Humidity: $90 \sim 95\%$ / Time: 500hrsMeasured after exposure in the room condition for 24hrs			
No 1-2-1 1-2-2	Item Temperature Cycle Humidity Resistance High	e Specification Appearance: No damage Inductance:within±20% of	One cycle:Temperature (°C)Time (min)1 -40 ± 3 302 25 ± 2 33 125 ± 3 304 25 ± 2 3Total: 100cycles $1000000000000000000000000000000000000$			
No 1-2-1 1-2-2	Item Temperature Cycle Humidity Resistance	e Specification Appearance: No damage Inductance:within±20% of	One cycle:Temperature (°C)Time (min)1 -40 ± 3 302 25 ± 2 33 125 ± 3 304 25 ± 2 3Total: 100cycles1Measured after exposure in the room condition for 24hrsTemperature: $60\pm2^{\circ}C$ Relative Humidity: $90 \sim 95\%$ / Time: $500hrs$ Measured after exposure in the room condition for 24hrsTemperature: $85\pm3^{\circ}C$ Relative Humidity: 0% / Time: $500hrs$			
No 1-2-1 1-2-2 1-2-3	Item Temperature Cycle Humidity Resistance High Temperature Resistance	e Specification Appearance: No damage Inductance:within±20% of	One cycle:Temperature (°C)Time (min)1 -40 ± 3 302 25 ± 2 33 125 ± 3 304 25 ± 2 3Total: 100cyclesImage: Constraint of the second secon			
No 1-2-1 1-2-2 1-2-3	Item Temperature Cycle Humidity Resistance High	e Specification Appearance: No damage Inductance:within±20% of	One cycle:Temperature (°C)Time (min)1 -40 ± 3 302 25 ± 2 33 125 ± 3 r 4 25 ± 2 3Total: 100cycles r Measured after exposure in the room condition for 24hrsTemperature: $60\pm2^{\circ}C$ Relative Humidity: $90 \sim 95\%$ / Time: $500hrs$ Measured after exposure in the room condition for 24hrsTemperature: $85\pm3^{\circ}C$ Relative Humidity: 0% / Time: $500hrs$			
No 1-2-1 1-2-2 1-2-3	Item Temperature Cycle Humidity Resistance High Temperature Resistance	e Specification Appearance: No damage Inductance:within±20% of	One cycle:Temperature (°C)Time (min)1 -40 ± 3 302 25 ± 2 33 125 ± 3 125 ± 3 4 25 ± 2 3Total: 100cycles 125 ± 2 Measured after exposure in the room condition for 24hrsTemperature: $60\pm2^{\circ}C$ Relative Humidity: $90 \sim 95\%$ / Time: $500hrs$ Measured after exposure in the room condition for 24hrsTemperature: $85\pm3^{\circ}C$ Relative Humidity: 0% / Time: $500hrs$ Measured after exposure in the room condition for 24hrsTemperature: $85\pm3^{\circ}C$ Measured after exposure in the room condition for 24hrsMeasured after exposure in the room condition for 24hrsTemperature: $85\pm3^{\circ}C$ Measured after exposure in the room condition for 24hrsMeasured after exposure in the room condition for 24hrs			



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管制項目 Item.	升溫區 Ramp-up	預熱區 Pre-heatimg	迴焊區 Reflow	Peak Temp	冷卻區 Cooling
溫度範圍 Temp.scope	$P T = 150\%$ 150% 200% 217% $1.260\pm$		260±5° ℃	Peak Temp. ~ 150℃	
標準時間 Time spec.	-	60 ~ 180 sec	60 ~ 150sec	20 ~ 40 sec	—
	—	75 ~ 100 sec	90 ~ 120sec	20 ~ 35 sec	-

NOTE:

1. Re-flow possible times : within 2 times

2. Nitrogen adopted is recommended while in re-flow

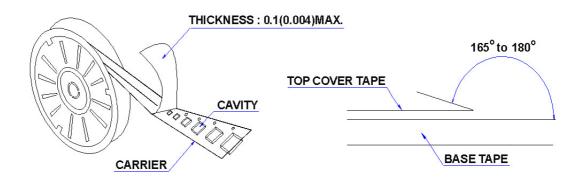


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10 Packaging:

10.1 Packaging -Cover Tape

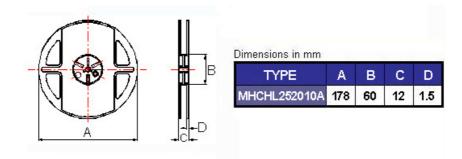
The force for tearing off cover tape is 10 to 100 grams in the arrow direction.



10.2 Packaging Quantity

ТҮРЕ	PCS/REEL
MHCHL252010A	3000

10.3 Reel Dimensions



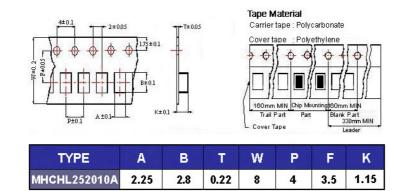


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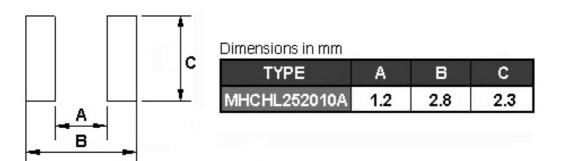
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10 Packaging:

10.4 Tape Dimensions in mm



11 Recommended Land Pattern:



12 Note:

- 1. Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.
- 2. Do not knock nor drop.
- 3. All the items and parameters in this product specification have been prescribed on the premise that our product is used for the purpose, under the condition and in the environment agreed upon between you and us. You are requested not to use our product deviating from such agreement.
- 4. Please keep the distance between transformer/coil and other components (refer to the standard IEC 950)
- 5.After manufacturing process, there might be slight irregular shape on the edge of the products, and it's a normal phenomenon that can be neglected
- 6.The moisture sensitivity level (MSL) of products is classified as level 1.



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